

# **MOSFET**

# OptiMOS<sup>™</sup>5 Power-Transistor, 60 V

### **Features**

- Optimized for synchronous rectification100% avalanche testedSuperior thermal performance

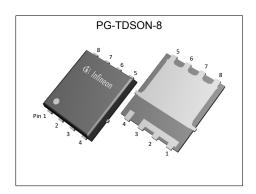
- 175°C rated
- N-channel
- Pb-free lead plating : RoHS compliant
  Halogen-free according to EC61249-2-21

### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

**Kev Performance Parameters** Table 1

Table 1 1toy 1 of formation 1 aramotore							
Parameter	Value	Unit					
$V_{ m DS}$	60	V					
R <sub>DS(on),max</sub>	1.15	mΩ					
I <sub>D</sub>	288	A					
Qoss	103	nC					
Q <sub>G</sub> (0V4.5V)	63	nC					











Type / Ordering Code	Package	Marking	Related Links
ISC011N06LM5	PG-TDSON-8 FL	011N06L	-

# OptiMOS<sup>TM</sup>5 Power-Transistor, 60 V ISC011N06LM5



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# OptiMOS<sup>™</sup>5 Power-Transistor, 60 V ISC011N06LM5



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Damamatan	Cyron b o l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	-	288 204 37	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1152	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	570	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	188 3.0	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	0.6	0.8	°C/W	-
Thermal resistance, junction - case, top	R <sub>thJC</sub>	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area	R <sub>thJA</sub>	-	-	50	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information

# OptiMOS<sup>TM</sup>5 Power-Transistor, 60 V ISC011N06LM5



## 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	1.1	-	2.3	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =116 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.85 1.1	1.15 1.45	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =4.5 V, I <sub>D</sub> =25 A
Gate resistance	R <sub>G</sub>	-	1.9	-	Ω	-
Transconductance	<b>g</b> fs	-	230	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 50 \text{ A}$

Table 5 Dynamic characteristics

Developer	Symbol	Values			11	Note / Took Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	8500	11000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1700	2300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	68	90	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{d(on)}$	-	7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	10	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	78	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	32	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	Cumbal	Values			11::4	Nata / Tast Canditian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{gs}$	-	21	-	nC	$V_{DD}$ =30 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Gate charge at threshold	Q <sub>g(th)</sub>	-	14	-	nC	$V_{DD}$ =30 V, $I_{D}$ =50 A, $V_{GS}$ =0 to 4.5 V
Gate to drain charge	$Q_{\mathrm{gd}}$	-	18	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	25	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	63	84	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	2.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total <sup>1)</sup>	Qg	-	127	170	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	118	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge	Qoss	-	103	-	nC	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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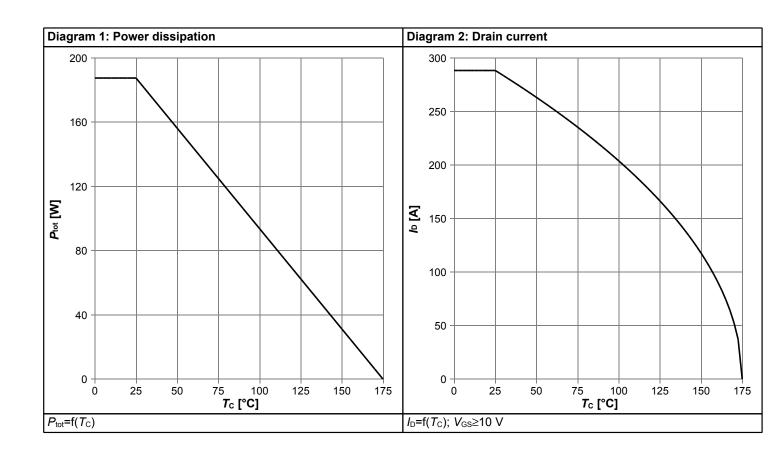


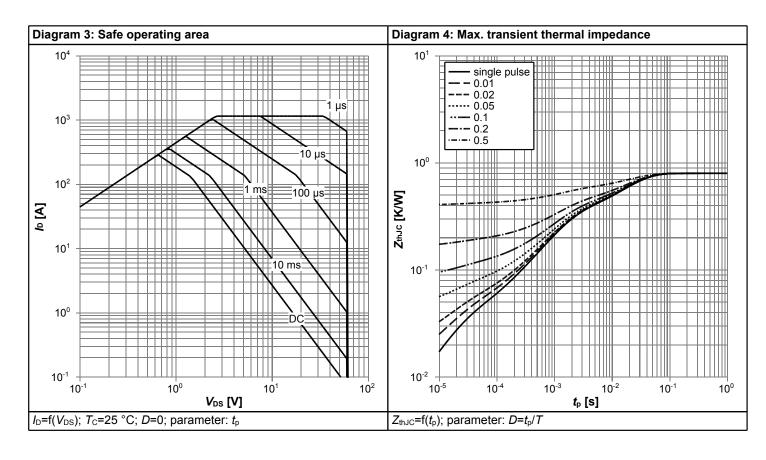
## Table 7 Reverse diode

Davamatar	Symbol		Values			Nata / Tank Candikina	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	153	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	1152	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.80	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	56	-	ns	$V_R$ =30 V, $I_F$ =50 A, $di_F/dt$ =100 A/ $\mu$ s	
Reverse recovery charge	Qrr	-	73	_	nC	$V_R$ =30 V, $I_F$ =50 A, $di_F/dt$ =100 A/ $\mu$ s	

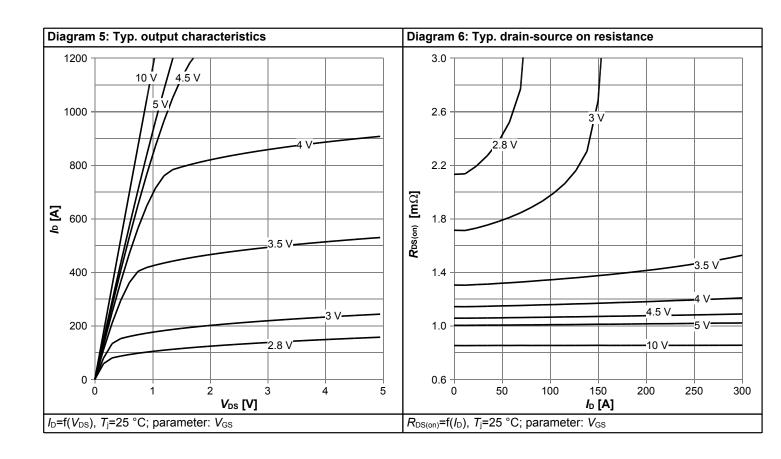


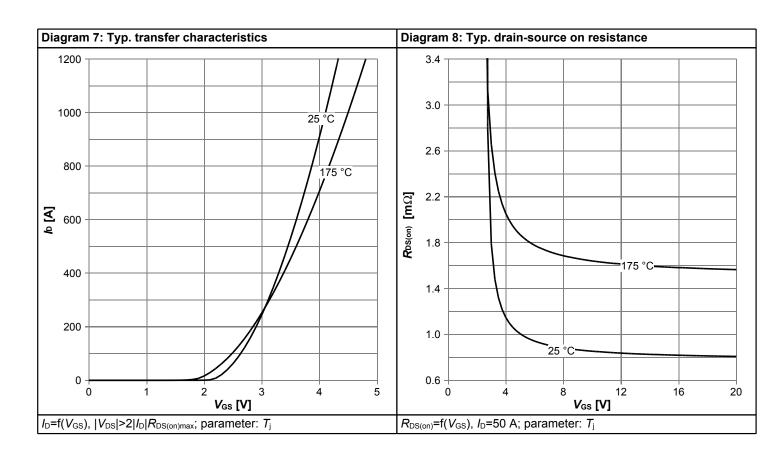
# 4 Electrical characteristics diagrams



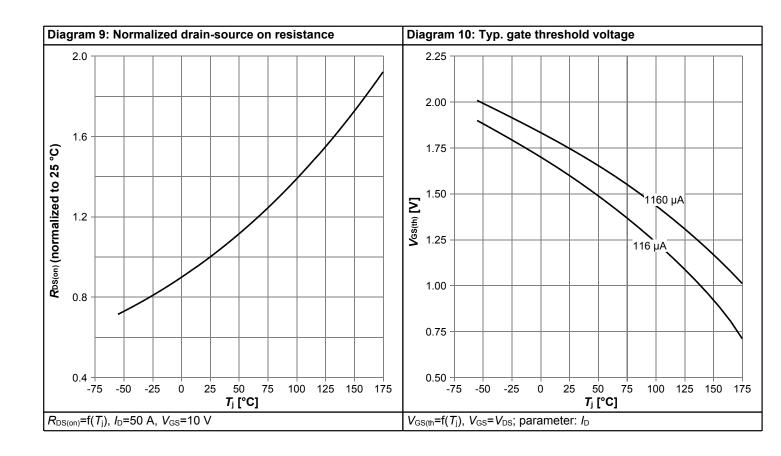


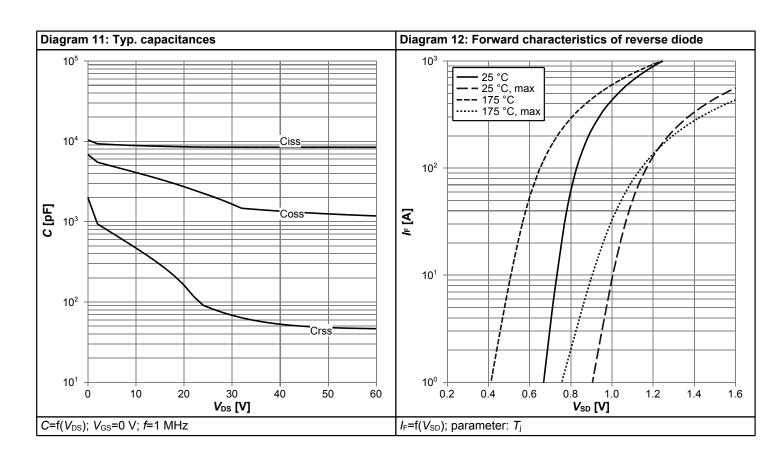




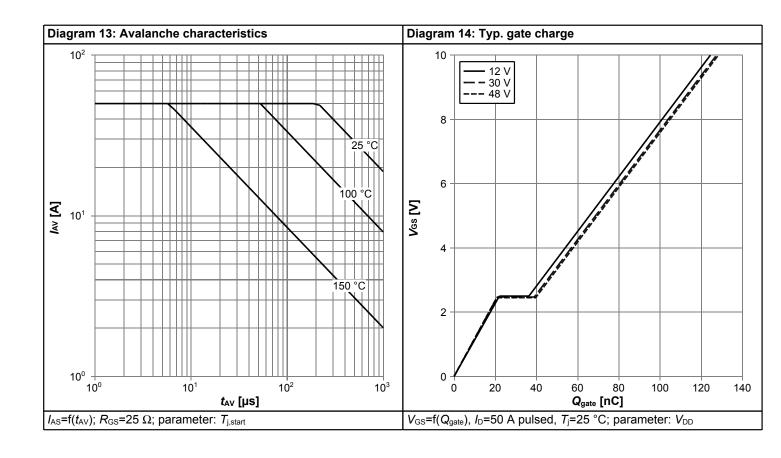


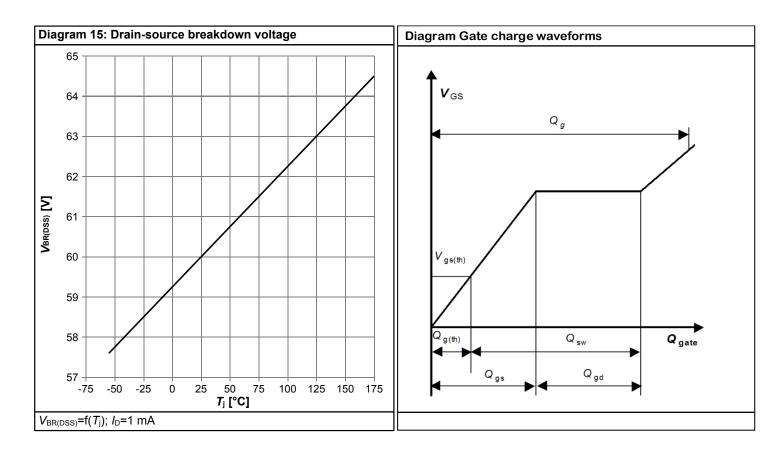














# 5 Package Outlines

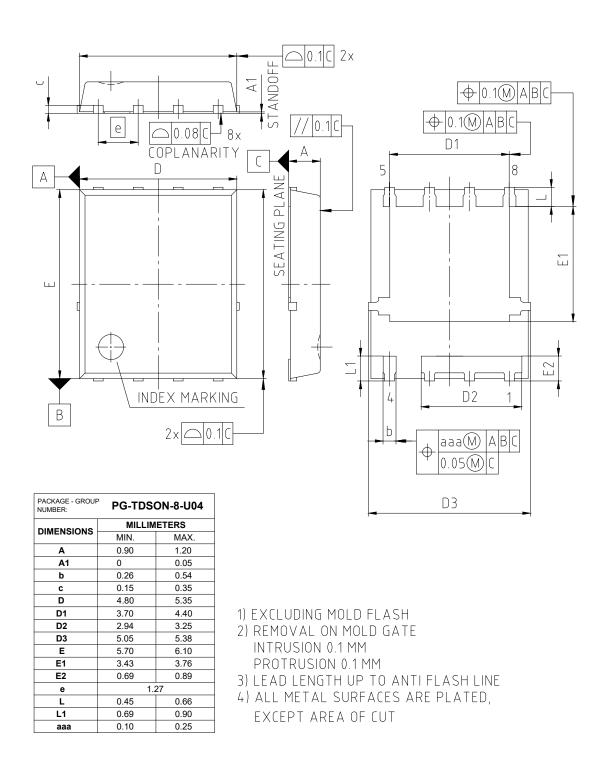


Figure 1 Outline PG-TDSON-8 FL, dimensions in mm

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### **Revision History**

ISC011N06LM5

Revision: 2022-09-23, Rev. 2.2

Previous Revision

FIEVIOUS REVISION						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-03-12	Release of final version				
2.1	2021-07-02	Update max Rdson				
2.2	2022-09-23	Update package outline drawing and footnotes				

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